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Details

Product Status	Obsolete
Core Processor	AVR
Core Size	8-Bit
Speed	10MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	23
Program Memory Size	4KB (2K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 6x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/atmel/atmega48v-10pi

Table 6-4. Start-up Times for the Low Power Crystal Oscillator Clock Selection (Continued)

Oscillator Source / Power Conditions	Start-up Time from Power-down and Power-save	Additional Delay from Reset ($V_{CC} = 5.0V$)	CKSELO	SUT1..0
Crystal Oscillator, BOD enabled	16K CK	14CK	1	01
Crystal Oscillator, fast rising power	16K CK	14CK + 4.1 ms	1	10
Crystal Oscillator, slowly rising power	16K CK	14CK + 65 ms	1	11

- Notes:
1. These options should only be used when not operating close to the maximum frequency of the device, and only if frequency stability at start-up is not important for the application. These options are not suitable for crystals.
 2. These options are intended for use with ceramic resonators and will ensure frequency stability at start-up. They can also be used with crystals when not operating close to the maximum frequency of the device, and if frequency stability at start-up is not important for the application.

6.4 Full Swing Crystal Oscillator

Pins XTAL1 and XTAL2 are input and output, respectively, of an inverting amplifier which can be configured for use as an On-chip Oscillator, as shown in [Figure 6-2](#). Either a quartz crystal or a ceramic resonator may be used.

This Crystal Oscillator is a full swing oscillator, with rail-to-rail swing on the XTAL2 output. This is useful for driving other clock inputs and in noisy environments. The current consumption is higher than the "Low Power Crystal Oscillator" on page 27. Note that the Full Swing Crystal Oscillator will only operate for $V_{CC} = 2.7 - 5.5$ volts.

C1 and C2 should always be equal for both crystals and resonators. The optimal value of the capacitors depends on the crystal or resonator in use, the amount of stray capacitance, and the electromagnetic noise of the environment. Some initial guidelines for choosing capacitors for use with crystals are given in [Table 6-6](#). For ceramic resonators, the capacitor values given by the manufacturer should be used.

The operating mode is selected by the fuses CKSEL3..1 as shown in [Table 6-5](#).

Table 6-5. Full Swing Crystal Oscillator operating modes⁽²⁾

Frequency Range ⁽¹⁾ (MHz)	Recommended Range for Capacitors C1 and C2 (pF)	CKSEL3..1
0.4 - 20	12 - 22	011

- Notes:
1. The frequency ranges are preliminary values. Actual values are TBD.
 2. If 8 MHz frequency exceeds the specification of the device (depends on V_{CC}), the CKDIV8 Fuse can be programmed in order to divide the internal frequency by 8. It must be ensured that the resulting divided clock meets the frequency specification of the device.

some cases, the input logic is needed for detecting wake-up conditions, and it will then be enabled. Refer to the section ["Digital Input Enable and Sleep Modes" on page 68](#) for details on which pins are enabled. If the input buffer is enabled and the input signal is left floating or have an analog signal level close to $V_{CC}/2$, the input buffer will use excessive power.

For analog input pins, the digital input buffer should be disabled at all times. An analog signal level close to $V_{CC}/2$ on an input pin can cause significant current even in active mode. Digital input buffers can be disabled by writing to the Digital Input Disable Registers (DIDR1 and DIDR0). Refer to ["Digital Input Disable Register 1 – DIDR1" on page 238](#) and ["Digital Input Disable Register 0 – DIDR0" on page 254](#) for details.

7.7.7 On-chip Debug System

If the On-chip debug system is enabled by the DWEN Fuse and the chip enters sleep mode, the main clock source is enabled and hence always consumes power. In the deeper sleep modes, this will contribute significantly to the total current consumption.

Table 9-1. Reset and Interrupt Vectors in ATmega48 (Continued)

Vector No.	Program Address	Source	Interrupt Definition
24	0x017	ANALOG COMP	Analog Comparator
25	0x018	TWI	2-wire Serial Interface
26	0x019	SPM READY	Store Program Memory Ready

The most typical and general program setup for the Reset and Interrupt Vector Addresses in ATmega48 is:

```

Address  Labels Code           Comments
0x000          rjmp  RESET           ; Reset Handler
0x001          rjmp  EXT_INT0        ; IRQ0 Handler
0x002          rjmp  EXT_INT1        ; IRQ1 Handler
0x003          rjmp  PCINT0         ; PCINT0 Handler
0x004          rjmp  PCINT1         ; PCINT1 Handler
0x005          rjmp  PCINT2         ; PCINT2 Handler
0x006          rjmp  WDT             ; Watchdog Timer Handler
0x007          rjmp  TIM2_COMPA      ; Timer2 Compare A Handler
0x008          rjmp  TIM2_COMPB     ; Timer2 Compare B Handler
0x009          rjmp  TIM2_OVF       ; Timer2 Overflow Handler
0x00A          rjmp  TIM1_CAPT      ; Timer1 Capture Handler
0x00B          rjmp  TIM1_COMPA     ; Timer1 Compare A Handler
0x00C          rjmp  TIM1_COMPB     ; Timer1 Compare B Handler
0x00D          rjmp  TIM1_OVF       ; Timer1 Overflow Handler
0x00E          rjmp  TIM0_COMPA     ; Timer0 Compare A Handler
0x00F          rjmp  TIM0_COMPB     ; Timer0 Compare B Handler
0x010          rjmp  TIM0_OVF       ; Timer0 Overflow Handler
0x011          rjmp  SPI_STC        ; SPI Transfer Complete Handler
0x012          rjmp  USART_RXC      ; USART, RX Complete Handler
0x013          rjmp  USART_UDRE     ; USART, UDR Empty Handler
0x014          rjmp  USART_TXC      ; USART, TX Complete Handler
0x015          rjmp  ADC            ; ADC Conversion Complete Handler
0x016          rjmp  EE_RDY         ; EEPROM Ready Handler
0x017          rjmp  ANA_COMP       ; Analog Comparator Handler
0x018          rjmp  TWI            ; 2-wire Serial Interface Handler
0x019          rjmp  SPM_RDY        ; Store Program Memory Ready Handler
;
0x01ARESET:    ldi    r16, high(RAMEND); Main program start
0x01B          out    SPH,r16        ; Set Stack Pointer to top of RAM
0x01C          ldi    r16, low(RAMEND)
0x01D          out    SPL,r16
0x01E          sei                      ; Enable interrupts
0x01F          <instr> xxx
...           ...           ...

```

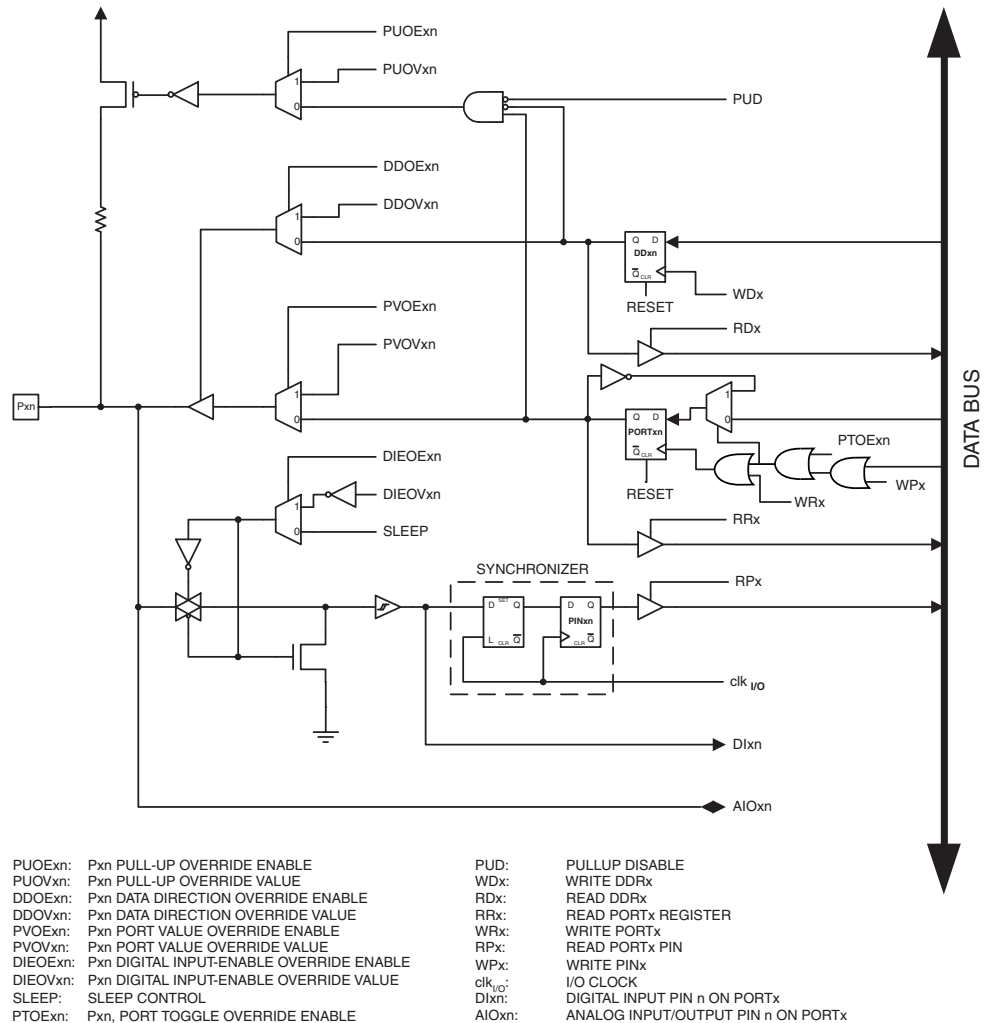
ing inputs should be avoided to reduce current consumption in all other modes where the digital inputs are enabled (Reset, Active mode and Idle mode).

The simplest method to ensure a defined level of an unused pin, is to enable the internal pull-up. In this case, the pull-up will be disabled during reset. If low power consumption during reset is important, it is recommended to use an external pull-up or pull-down. Connecting unused pins directly to V_{CC} or GND is not recommended, since this may cause excessive currents if the pin is accidentally configured as an output.

10.3 Alternate Port Functions

Most port pins have alternate functions in addition to being general digital I/Os. Figure 10-5 shows how the port pin control signals from the simplified Figure 10-2 can be overridden by alternate functions. The overriding signals may not be present in all port pins, but the figure serves as a generic description applicable to all port pins in the AVR microcontroller family.

Figure 10-5. Alternate Port Functions⁽¹⁾



Note: 1. WR_x, WP_x, WD_x, RR_x, RP_x, and RD_x are common to all pins within the same port. clk_{I/O}, SLEEP, and PUD are common to all ports. All other signals are unique for each pin.

12. 8-bit Timer/Counter0 with PWM

Timer/Counter0 is a general purpose 8-bit Timer/Counter module, with two independent Output Compare Units, and with PWM support. It allows accurate program execution timing (event management) and wave generation. The main features are:

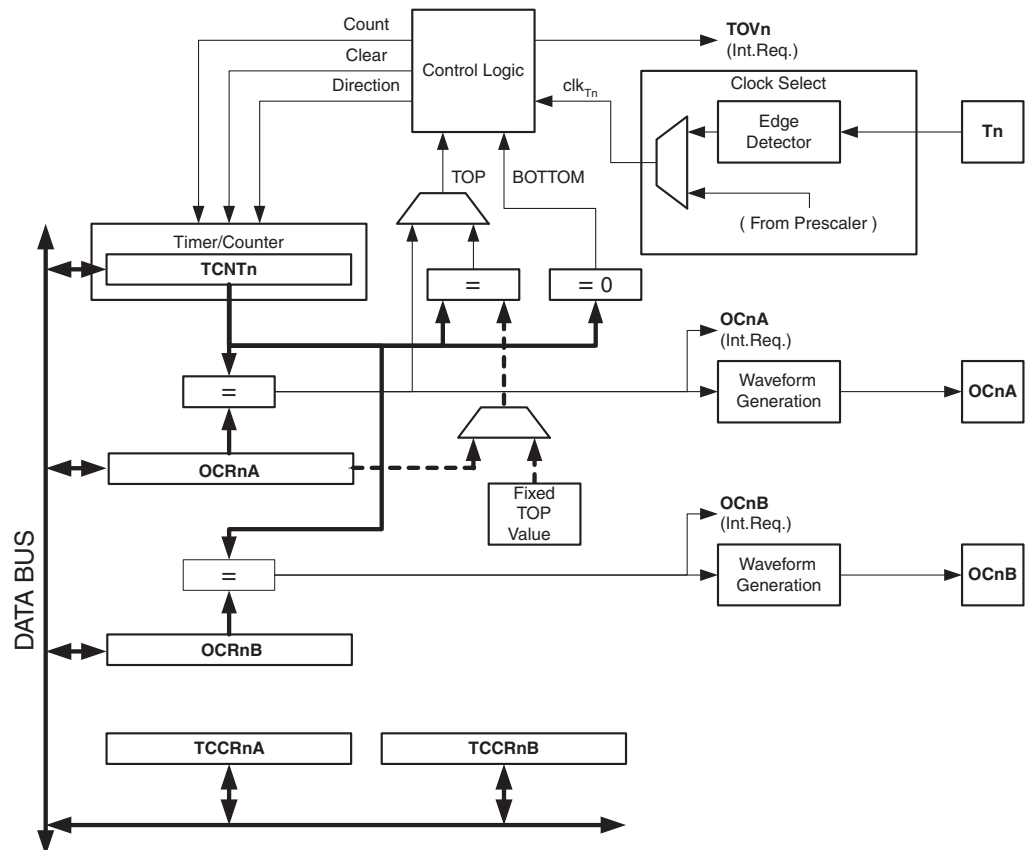
- Two Independent Output Compare Units
- Double Buffered Output Compare Registers
- Clear Timer on Compare Match (Auto Reload)
- Glitch Free, Phase Correct Pulse Width Modulator (PWM)
- Variable PWM Period
- Frequency Generator
- Three Independent Interrupt Sources (TOV0, OCF0A, and OCF0B)

12.1 Overview

A simplified block diagram of the 8-bit Timer/Counter is shown in [Figure 12-1](#). For the actual placement of I/O pins, refer to ["Pinout ATmega48/88/168" on page 2](#). CPU accessible I/O Registers, including I/O bits and I/O pins, are shown in bold. The device-specific I/O Register and bit locations are listed in the ["8-bit Timer/Counter Register Description" on page 99](#).

The PRTIM0 bit in ["Power Reduction Register - PRR" on page 40](#) must be written to zero to enable Timer/Counter0 module.

Figure 12-1. 8-bit Timer/Counter Block Diagram



Assembly Code Example⁽¹⁾

```
TIM16_ReadTCNT1:
    ; Save global interrupt flag
    in r18,SREG
    ; Disable interrupts
    cli
    ; Read TCNT1 into r17:r16
    in r16,TCNT1L
    in r17,TCNT1H
    ; Restore global interrupt flag
    out SREG,r18
    ret
```

C Code Example⁽¹⁾

```
unsigned int TIM16_ReadTCNT1( void )
{
    unsigned char sreg;
    unsigned int i;
    /* Save global interrupt flag */
    sreg = SREG;
    /* Disable interrupts */
    _CLI();
    /* Read TCNT1 into i */
    i = TCNT1;
    /* Restore global interrupt flag */
    SREG = sreg;
    return i;
}
```

Note: 1. See ["About Code Examples" on page 6](#).

For I/O Registers located in extended I/O map, "IN", "OUT", "SBIS", "SBIC", "CBI", and "SBI" instructions must be replaced with instructions that allow access to extended I/O. Typically "LDS" and "STS" combined with "SBR", "SBRC", "SBR", and "CBR".

The assembly code example returns the TCNT1 value in the r17:r16 register pair.

The following code examples show how to do an atomic write of the TCNT1 Register contents. Writing any of the OCR1A/B or ICR1 Registers can be done by using the same principle.

When the ICR1 is used as TOP value (see description of the WGM13:0 bits located in the TCCR1A and the TCCR1B Register), the ICP1 is disconnected and consequently the Input Capture function is disabled.

- **Bit 5 – Reserved Bit**

This bit is reserved for future use. For ensuring compatibility with future devices, this bit must be written to zero when TCCR1B is written.

- **Bit 4:3 – WGM13:2: Waveform Generation Mode**

See TCCR1A Register description.

- **Bit 2:0 – CS12:0: Clock Select**

The three Clock Select bits select the clock source to be used by the Timer/Counter, see [Figure 13-10](#) and [Figure 13-11](#).

Table 13-5. Clock Select Bit Description

CS12	CS11	CS10	Description
0	0	0	No clock source (Timer/Counter stopped).
0	0	1	clk _{I/O} /1 (No prescaling)
0	1	0	clk _{I/O} /8 (From prescaler)
0	1	1	clk _{I/O} /64 (From prescaler)
1	0	0	clk _{I/O} /256 (From prescaler)
1	0	1	clk _{I/O} /1024 (From prescaler)
1	1	0	External clock source on T1 pin. Clock on falling edge.
1	1	1	External clock source on T1 pin. Clock on rising edge.

If external pin modes are used for the Timer/Counter1, transitions on the T1 pin will clock the counter even if the pin is configured as an output. This feature allows software control of the counting.

13.10.3 Timer/Counter1 Control Register C – TCCR1C

Bit	7	6	5	4	3	2	1	0	
	FOC1A	FOC1B	–	–	–	–	–	–	TCCR1C
Read/Write	R/W	R/W	R	R	R	R	R	R	
Initial Value	0	0	0	0	0	0	0	0	

- **Bit 7 – FOC1A: Force Output Compare for Channel A**

- **Bit 6 – FOC1B: Force Output Compare for Channel B**

The FOC1A/FOC1B bits are only active when the WGM13:0 bits specifies a non-PWM mode. However, for ensuring compatibility with future devices, these bits must be set to zero when TCCR1A is written when operating in a PWM mode. When writing a logical one to the FOC1A/FOC1B bit, an immediate compare match is forced on the Waveform Generation unit. The OC1A/OC1B output is changed according to its COM1x1:0 bits setting. Note that the FOC1A/FOC1B bits are implemented as strobes. Therefore it is the value present in the COM1x1:0 bits that determine the effect of the forced compare.

14. Timer/Counter0 and Timer/Counter1 Prescalers

"8-bit Timer/Counter0 with PWM" on page 88 and "16-bit Timer/Counter1 with PWM" on page 106 share the same prescaler module, but the Timer/Counter0s can have different prescaler settings. The description below applies to both Timer/Counter1 and Timer/Counter0.

14.0.1 Internal Clock Source

The Timer/Counter can be clocked directly by the system clock (by setting the CSn2:0 = 1). This provides the fastest operation, with a maximum Timer/Counter clock frequency equal to system clock frequency ($f_{CLK_I/O}$). Alternatively, one of four taps from the prescaler can be used as a clock source. The prescaled clock has a frequency of either $f_{CLK_I/O}/8$, $f_{CLK_I/O}/64$, $f_{CLK_I/O}/256$, or $f_{CLK_I/O}/1024$.

14.0.2 Prescaler Reset

The prescaler is free running, i.e., operates independently of the Clock Select logic of the Timer/Counter, and it is shared by Timer/Counter1 and Timer/Counter0. Since the prescaler is not affected by the Timer/Counter's clock select, the state of the prescaler will have implications for situations where a prescaled clock is used. One example of prescaling artifacts occurs when the timer is enabled and clocked by the prescaler ($6 > CSn2:0 > 1$). The number of system clock cycles from when the timer is enabled to the first count occurs can be from 1 to N+1 system clock cycles, where N equals the prescaler divisor (8, 64, 256, or 1024).

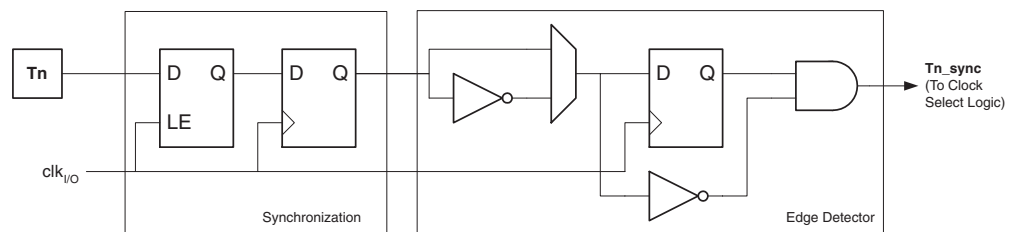
It is possible to use the prescaler reset for synchronizing the Timer/Counter to program execution. However, care must be taken if the other Timer/Counter that shares the same prescaler also uses prescaling. A prescaler reset will affect the prescaler period for all Timer/Counter0s it is connected to.

14.0.3 External Clock Source

An external clock source applied to the T1/T0 pin can be used as Timer/Counter clock (clk_{T1}/clk_{T0}). The T1/T0 pin is sampled once every system clock cycle by the pin synchronization logic. The synchronized (sampled) signal is then passed through the edge detector. Figure 14-1 shows a functional equivalent block diagram of the T1/T0 synchronization and edge detector logic. The registers are clocked at the positive edge of the internal system clock ($clk_{I/O}$). The latch is transparent in the high period of the internal system clock.

The edge detector generates one clk_{T1}/clk_{T0} pulse for each positive ($CSn2:0 = 7$) or negative ($CSn2:0 = 6$) edge it detects.

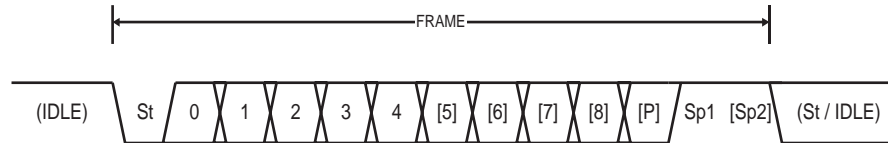
Figure 14-1. T1/T0 Pin Sampling



The synchronization and edge detector logic introduces a delay of 2.5 to 3.5 system clock cycles from an edge has been applied to the T1/T0 pin to the counter is updated.

A frame starts with the start bit followed by the least significant data bit. Then the next data bits, up to a total of nine, are succeeding, ending with the most significant bit. If enabled, the parity bit is inserted after the data bits, before the stop bits. When a complete frame is transmitted, it can be directly followed by a new frame, or the communication line can be set to an idle (high) state. Figure 17-4 illustrates the possible combinations of the frame formats. Bits inside brackets are optional.

Figure 17-4. Frame Formats



St	Start bit, always low.
(n)	Data bits (0 to 8).
P	Parity bit. Can be odd or even.
Sp	Stop bit, always high.
IDLE	No transfers on the communication line (RxDn or TxDn). An IDLE line must be high.

The frame format used by the USART is set by the UCSZn2:0, UPMn1:0 and USBSn bits in UCSRnB and UCSRnC. The Receiver and Transmitter use the same setting. Note that changing the setting of any of these bits will corrupt all ongoing communication for both the Receiver and Transmitter.

The USART Character SiZe (UCSZn2:0) bits select the number of data bits in the frame. The USART Parity mode (UPMn1:0) bits enable and set the type of parity bit. The selection between one or two stop bits is done by the USART Stop Bit Select (USBSn) bit. The Receiver ignores the second stop bit. An FE (Frame Error) will therefore only be detected in the cases where the first stop bit is zero.

17.3.1 Parity Bit Calculation

The parity bit is calculated by doing an exclusive-or of all the data bits. If odd parity is used, the result of the exclusive or is inverted. The relation between the parity bit and data bits is as follows:

$$P_{even} = d_{n-1} \oplus \dots \oplus d_3 \oplus d_2 \oplus d_1 \oplus d_0 \oplus 0$$

$$P_{odd} = d_{n-1} \oplus \dots \oplus d_3 \oplus d_2 \oplus d_1 \oplus d_0 \oplus 1$$

P_{even}	Parity bit using even parity
P_{odd}	Parity bit using odd parity
d_n	Data bit n of the character

If used, the parity bit is located between the last data bit and first stop bit of a serial frame.

17.6.3 Receive Complete Flag and Interrupt

The USART Receiver has one flag that indicates the Receiver state.

The Receive Complete (RXCn) Flag indicates if there are unread data present in the receive buffer. This flag is one when unread data exist in the receive buffer, and zero when the receive buffer is empty (i.e., does not contain any unread data). If the Receiver is disabled (RXENn = 0), the receive buffer will be flushed and consequently the RXCn bit will become zero.

When the Receive Complete Interrupt Enable (RXCIEn) in UCSRnB is set, the USART Receive Complete interrupt will be executed as long as the RXCn Flag is set (provided that global interrupts are enabled). When interrupt-driven data reception is used, the receive complete routine must read the received data from UDRn in order to clear the RXCn Flag, otherwise a new interrupt will occur once the interrupt routine terminates.

17.6.4 Receiver Error Flags

The USART Receiver has three Error Flags: Frame Error (FEn), Data OverRun (DORn) and Parity Error (UPEn). All can be accessed by reading UCSRnA. Common for the Error Flags is that they are located in the receive buffer together with the frame for which they indicate the error status. Due to the buffering of the Error Flags, the UCSRnA must be read before the receive buffer (UDRn), since reading the UDRn I/O location changes the buffer read location. Another equality for the Error Flags is that they can not be altered by software doing a write to the flag location. However, all flags must be set to zero when the UCSRnA is written for upward compatibility of future USART implementations. None of the Error Flags can generate interrupts.

The Frame Error (FEn) Flag indicates the state of the first stop bit of the next readable frame stored in the receive buffer. The FEn Flag is zero when the stop bit was correctly read (as one), and the FEn Flag will be one when the stop bit was incorrect (zero). This flag can be used for detecting out-of-sync conditions, detecting break conditions and protocol handling. The FEn Flag is not affected by the setting of the USBSn bit in UCSRnC since the Receiver ignores all, except for the first, stop bits. For compatibility with future devices, always set this bit to zero when writing to UCSRnA.

The Data OverRun (DORn) Flag indicates data loss due to a receiver buffer full condition. A Data OverRun occurs when the receive buffer is full (two characters), it is a new character waiting in the Receive Shift Register, and a new start bit is detected. If the DORn Flag is set there was one or more serial frame lost between the frame last read from UDRn, and the next frame read from UDRn. For compatibility with future devices, always write this bit to zero when writing to UCSRnA. The DORn Flag is cleared when the frame received was successfully moved from the Shift Register to the receive buffer.

The Parity Error (UPEn) Flag indicates that the next frame in the receive buffer had a Parity Error when received. If Parity Check is not enabled the UPEn bit will always be read zero. For compatibility with future devices, always set this bit to zero when writing to UCSRnA. For more details see ["Parity Bit Calculation" on page 173](#) and ["Parity Checker" on page 181](#).

17.6.5 Parity Checker

The Parity Checker is active when the high USART Parity mode (UPMn1) bit is set. Type of Parity Check to be performed (odd or even) is selected by the UPMn0 bit. When enabled, the Parity Checker calculates the parity of the data bits in incoming frames and compares the result with the parity bit from the serial frame. The result of the check is stored in the receive buffer together with the received data and stop bits. The Parity Error (UPEn) Flag can then be read by software to check if the frame had a Parity Error.

19. 2-wire Serial Interface

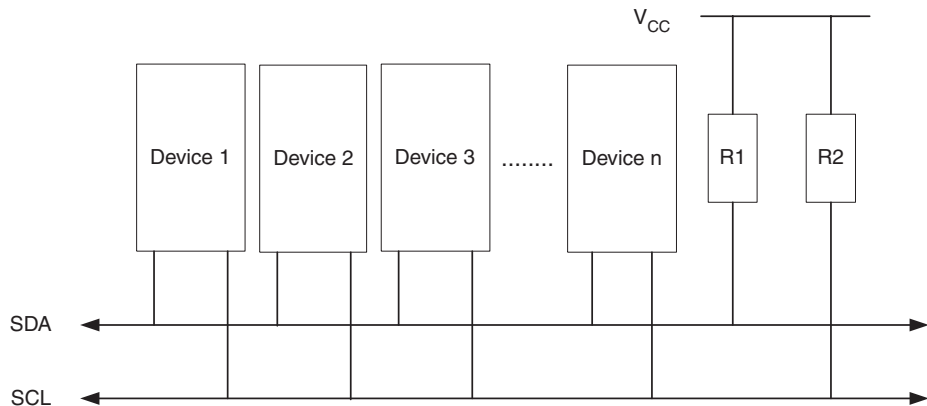
19.1 Features

- Simple Yet Powerful and Flexible Communication Interface, only two Bus Lines Needed
- Both Master and Slave Operation Supported
- Device can Operate as Transmitter or Receiver
- 7-bit Address Space Allows up to 128 Different Slave Addresses
- Multi-master Arbitration Support
- Up to 400 kHz Data Transfer Speed
- Slew-rate Limited Output Drivers
- Noise Suppression Circuitry Rejects Spikes on Bus Lines
- Fully Programmable Slave Address with General Call Support
- Address Recognition Causes Wake-up When AVR is in Sleep Mode

19.2 2-wire Serial Interface Bus Definition

The 2-wire Serial Interface (TWI) is ideally suited for typical microcontroller applications. The TWI protocol allows the systems designer to interconnect up to 128 different devices using only two bi-directional bus lines, one for clock (SCL) and one for data (SDA). The only external hardware needed to implement the bus is a single pull-up resistor for each of the TWI bus lines. All devices connected to the bus have individual addresses, and mechanisms for resolving bus contention are inherent in the TWI protocol.

Figure 19-1. TWI Bus Interconnection



19.2.1 TWI Terminology

The following definitions are frequently encountered in this section.

Table 19-1. TWI Terminology

Term	Description
Master	The device that initiates and terminates a transmission. The Master also generates the SCL clock.
Slave	The device addressed by a Master.
Transmitter	The device placing data on the bus.
Receiver	The device reading data from the bus.

- **Bit 6 – TWEA: TWI Enable Acknowledge Bit**

The TWEA bit controls the generation of the acknowledge pulse. If the TWEA bit is written to one, the ACK pulse is generated on the TWI bus if the following conditions are met:

1. The device's own slave address has been received.
2. A general call has been received, while the TWGCE bit in the TWAR is set.
3. A data byte has been received in Master Receiver or Slave Receiver mode.

By writing the TWEA bit to zero, the device can be virtually disconnected from the 2-wire Serial Bus temporarily. Address recognition can then be resumed by writing the TWEA bit to one again.

- **Bit 5 – TWSTA: TWI START Condition Bit**

The application writes the TWSTA bit to one when it desires to become a Master on the 2-wire Serial Bus. The TWI hardware checks if the bus is available, and generates a START condition on the bus if it is free. However, if the bus is not free, the TWI waits until a STOP condition is detected, and then generates a new START condition to claim the bus Master status. TWSTA must be cleared by software when the START condition has been transmitted.

- **Bit 4 – TWSTO: TWI STOP Condition Bit**

Writing the TWSTO bit to one in Master mode will generate a STOP condition on the 2-wire Serial Bus. When the STOP condition is executed on the bus, the TWSTO bit is cleared automatically. In Slave mode, setting the TWSTO bit can be used to recover from an error condition. This will not generate a STOP condition, but the TWI returns to a well-defined unaddressed Slave mode and releases the SCL and SDA lines to a high impedance state.

- **Bit 3 – TWWC: TWI Write Collision Flag**

The TWWC bit is set when attempting to write to the TWI Data Register – TWDR when TWINT is low. This flag is cleared by writing the TWDR Register when TWINT is high.

- **Bit 2 – TWEN: TWI Enable Bit**

The TWEN bit enables TWI operation and activates the TWI interface. When TWEN is written to one, the TWI takes control over the I/O pins connected to the SCL and SDA pins, enabling the slew-rate limiters and spike filters. If this bit is written to zero, the TWI is switched off and all TWI transmissions are terminated, regardless of any ongoing operation.

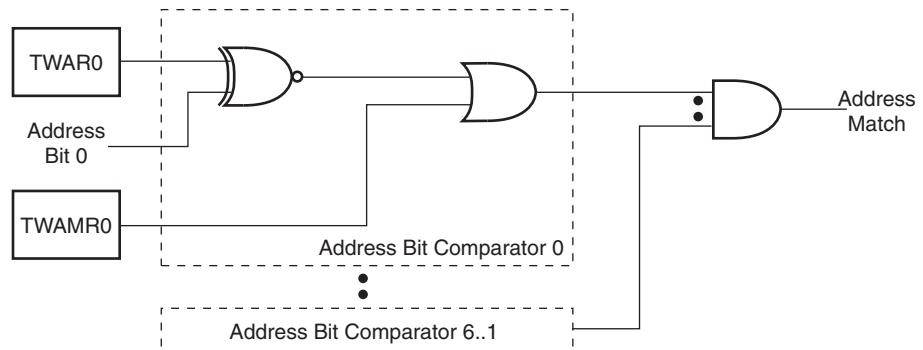
- **Bit 1 – Res: Reserved Bit**

This bit is a reserved bit and will always read as zero.

- **Bit 0 – TWIE: TWI Interrupt Enable**

When this bit is written to one, and the I-bit in SREG is set, the TWI interrupt request will be activated for as long as the TWINT Flag is high.

Figure 19-10. TWI Address Match Logic, Block Diagram



- **Bit 0 – Res: Reserved Bit**

This bit is an unused bit in the ATmega48/88/168, and will always read as zero.

19.7 Using the TWI

The AVR TWI is byte-oriented and interrupt based. Interrupts are issued after all bus events, like reception of a byte or transmission of a START condition. Because the TWI is interrupt-based, the application software is free to carry on other operations during a TWI byte transfer. Note that the TWI Interrupt Enable (TWIE) bit in TWCR together with the Global Interrupt Enable bit in SREG allow the application to decide whether or not assertion of the TWINT Flag should generate an interrupt request. If the TWIE bit is cleared, the application must poll the TWINT Flag in order to detect actions on the TWI bus.

When the TWINT Flag is asserted, the TWI has finished an operation and awaits application response. In this case, the TWI Status Register (TWSR) contains a value indicating the current state of the TWI bus. The application software can then decide how the TWI should behave in the next TWI bus cycle by manipulating the TWCR and TWDR Registers.

Figure 19-11 is a simple example of how the application can interface to the TWI hardware. In this example, a Master wishes to transmit a single data byte to a Slave. This description is quite abstract, a more detailed explanation follows later in this section. A simple code example implementing the desired behavior is also presented.

20-2. If ACME is cleared or ADEN is set, AIN1 is applied to the negative input to the Analog Comparator.

Table 20-2. Analog Comparator Multiplexed Input

ACME	ADEN	MUX2..0	Analog Comparator Negative Input
0	x	xxx	AIN1
1	1	xxx	AIN1
1	0	000	ADC0
1	0	001	ADC1
1	0	010	ADC2
1	0	011	ADC3
1	0	100	ADC4
1	0	101	ADC5
1	0	110	ADC6
1	0	111	ADC7

20.1.1 Digital Input Disable Register 1 – DIDR1

Bit	7	6	5	4	3	2	1	0		
	-							AIN1D	AIN0D	DIDR1
Read/Write	R	R	R	R	R	R	R/W	R/W		
Initial Value	0	0	0	0	0	0	0	0		

- **Bit 7..2 – Res: Reserved Bits**

These bits are unused bits in the ATmega48/88/168, and will always read as zero.

- **Bit 1, 0 – AIN1D, AIN0D: AIN1, AIN0 Digital Input Disable**

When this bit is written logic one, the digital input buffer on the AIN1/0 pin is disabled. The corresponding PIN Register bit will always read as zero when this bit is set. When an analog signal is applied to the AIN1/0 pin and the digital input from this pin is not needed, this bit should be written logic one to reduce power consumption in the digital input buffer.

shown below. See [Table 25-5 on page 282](#) for detailed description and mapping of the Extended Fuse byte.

Bit	7	6	5	4	3	2	1	0
Rd	FHB7	FHB6	FHB5	FHB4	FHB3	FHB2	FHB1	FHB0

Fuse and Lock bits that are programmed, will be read as zero. Fuse and Lock bits that are unprogrammed, will be read as one.

23.1.4 Preventing Flash Corruption

During periods of low V_{CC} , the Flash program can be corrupted because the supply voltage is too low for the CPU and the Flash to operate properly. These issues are the same as for board level systems using the Flash, and the same design solutions should be applied.

A Flash program corruption can be caused by two situations when the voltage is too low. First, a regular write sequence to the Flash requires a minimum voltage to operate correctly. Secondly, the CPU itself can execute instructions incorrectly, if the supply voltage for executing instructions is too low.

Flash corruption can easily be avoided by following these design recommendations (one is sufficient):

1. Keep the AVR RESET active (low) during periods of insufficient power supply voltage. This can be done by enabling the internal Brown-out Detector (BOD) if the operating voltage matches the detection level. If not, an external low V_{CC} reset protection circuit can be used. If a reset occurs while a write operation is in progress, the write operation will be completed provided that the power supply voltage is sufficient.
2. Keep the AVR core in Power-down sleep mode during periods of low V_{CC} . This will prevent the CPU from attempting to decode and execute instructions, effectively protecting the SPMCSR Register and thus the Flash from unintentional writes.

23.1.5 Programming Time for Flash when Using SPM

The calibrated RC Oscillator is used to time Flash accesses. [Table 24-5](#) shows the typical programming time for Flash accesses from the CPU.

Table 23-1. SPM Programming Time

Symbol	Min Programming Time	Max Programming Time
Flash write (Page Erase, Page Write, and write Lock bits by SPM)	3.7 ms	4.5 ms

23.1.6 Simple Assembly Code Example for a Boot Loader

Note that the RWWSB bit will always be read as zero in ATmega48. Nevertheless, it is recommended to check this bit as shown in the code example, to ensure compatibility with devices supporting Read-While-Write.


```

; return to RWW section
; verify that RWW section is safe to read
Return:
in temp1, SPMCSR
sbrs temp1, RWWSB ; If RWWSB is set, the RWW section is not ready yet
ret
; re-enable the RWW section
ldi spmcrval, (1<<RWWSRE) | (1<<SELFPRGEN)
call Do_spm
rjmp Return

Do_spm:
; check for previous SPM complete
Wait_spm:
in temp1, SPMCSR
sbrs temp1, SELFPRGEN
rjmp Wait_spm
; input: spmcrval determines SPM action
; disable interrupts if enabled, store status
in temp2, SREG
cli
; check that no EEPROM write access is present
Wait_ee:
sbic EECR, EEPE
rjmp Wait_ee
; SPM timed sequence
out SPMCSR, spmcrval
spm
; restore SREG (to enable interrupts if originally enabled)
out SREG, temp2
ret

```

24.7.13 ATmega88 Boot Loader Parameters

In [Table 24-6](#) through [Table 24-8](#), the parameters used in the description of the self programming are given.

Table 24-6. Boot Size Configuration, ATmega88

BOOTSZ1	BOOTSZ0	Boot Size	Pages	Application Flash Section	Boot Loader Flash Section	End Application Section	Boot Reset Address (Start Boot Loader Section)
1	1	128 words	4	0x000 - 0xF7F	0xF80 - 0xFFF	0xF7F	0xF80
1	0	256 words	8	0x000 - 0xEFF	0xF00 - 0xFFF	0xEFF	0xF00
0	1	512 words	16	0x000 - 0xDFF	0xE00 - 0xFFF	0xDFF	0xE00
0	0	1024 words	32	0x000 - 0xBFF	0xC00 - 0xFFF	0xBFF	0xC00

30. Ordering Information

30.1 ATmega48

Speed (MHz)	Power Supply	Ordering Code	Package ⁽¹⁾	Operational Range
10 ⁽³⁾	1.8 - 5.5	ATmega48V-10AI ATmega48V-10PI ATmega48V-10MI ATmega48V-10AU ⁽²⁾ ATmega48V-10PU ⁽²⁾ ATmega48V-10MU ⁽²⁾	32A 28P3 32M1-A 32A 28P3 32M1-A	Industrial (-40°C to 85°C)
20 ⁽³⁾	2.7 - 5.5	ATmega48-20AI ATmega48-20PI ATmega48-20MI ATmega48-20AU ⁽²⁾ ATmega48-20PU ⁽²⁾ ATmega48-20MU ⁽²⁾	32A 28P3 32M1-A 32A 28P3 32M1-A	Industrial (-40°C to 85°C)

- Note:
1. This device can also be supplied in wafer form. Please contact your local Atmel sales office for detailed ordering information and minimum quantities.
 2. Pb-free packaging alternative, complies to the European Directive for Restriction of Hazardous Substances (RoHS directive). Also Halide free and fully Green.
 3. See [Figure 26-2 on page 302](#) and [Figure 26-3 on page 302](#).

Package Type	
32A	32-lead, Thin (1.0 mm) Plastic Quad Flat Package (TQFP)
28P3	28-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)
32M1-A	32-pad, 5 x 5 x 1.0 body, Lead Pitch 0.50 mm Quad Flat No-Lead/Micro Lead Frame Package (QFN/MLF)

32.3 Errata ATmega168

The revision letter in this section refers to the revision of the ATmega168 device.

32.3.1 Rev A

- **Wrong values read after Erase Only operation**
- **Part may hang in reset**

1. Wrong values read after Erase Only operation

At supply voltages below 2.7 V, an EEPROM location that is erased by the Erase Only operation may read as programmed (0x00).

Problem Fix/Workaround

If it is necessary to read an EEPROM location after Erase Only, use an Atomic Write operation with 0xFF as data in order to erase a location. In any case, the Write Only operation can be used as intended. Thus no special considerations are needed as long as the erased location is not read before it is programmed.

2. Part may hang in reset

Some parts may get stuck in a reset state when a reset signal is applied when the internal reset state-machine is in a specific state. The internal reset state-machine is in this state for approximately 10 ns immediately before the part wakes up after a reset, and in a 10 ns window when altering the system clock prescaler. The problem is most often seen during In-System Programming of the device. There are theoretical possibilities of this happening also in run-mode. The following three cases can trigger the device to get stuck in a reset-state:

- Two succeeding resets are applied where the second reset occurs in the 10ns window before the device is out of the reset-state caused by the first reset.
- A reset is applied in a 10 ns window while the system clock prescaler value is updated by software.
- Leaving SPI-programming mode generates an internal reset signal that can trigger this case.

The two first cases can occur during normal operating mode, while the last case occurs only during programming of the device.

Problem Fix/Workaround

The first case can be avoided during run-mode by ensuring that only one reset source is active. If an external reset push button is used, the reset start-up time should be selected such that the reset line is fully debounced during the start-up time.

The second case can be avoided by not using the system clock prescaler.

The third case occurs during In-System programming only. It is most frequently seen when using the internal RC at maximum frequency.

If the device gets stuck in the reset-state, turn power off, then on again to get the device out of this state.

32.3.2 Rev B

No errata.

32.3.3 Rev C

No errata.

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